

ISSUE 21 – NOVEMBER 2026

NEWS FROM the EIPC



Announcement

EIPC Winter Conference Germany

February 2 & 3, 2027
Visit: TKMS Atlas Elektronik GmbH Bremen

"Challenges and Opportunities in the changing Electronics & PCB Industry, focused on Defence"

One of the best countries in Europe to be in during the winter is Germany. Whilst Bavaria does ski-Ing, the fine city of Bremen offers a much safer place to be, where no one goes down any black runs, only green ones, and the only holes are ones that have been deliberately drilled.

The warmth of an EIPC convivial gathering is renowned and given that one fine delegate attended a previous winter event in a light suit whilst the snow went past the windows horizontally, some elements on wool would be recommended.

Also recommended is the sheer scale of topics to be covered, almost an avalanche of topics, and as usual the quality of the speakers will provide the lifts to the summit of excellence. So, be one of those who will provide a day or two to remember and have the pleasure of a visit to another peak, that one of the world's leading providers of integrated system solutions in maritime defence technologies, designed to meet the complex requirements of modern navies, TKMS Atlas Elektronik GmbH.

Please submit your abstract no later than Nov 20 to eipc@eipc.org

More info on the EIPC website.

We look forward to hearing from you!

The EIPC Team



Sponsoring EIPC Winter Conference 2027

The EIPC offers several possibilities for sponsoring the EIPC Winter Conference 2027.
Please find below the various opportunities that could be a great asset to your company's exposure.

A. GOLD:
One full colour advertisement in digital proceedings
Logo + link on EIPC website (event page)
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Table Top + Poster Presentation during conference, in coffee break area (material delivered by sponsor)
Rate: € 2000.-

B. SILVER:
Logo + link on EIPC website (event page)
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Table Top + Poster Presentation during conference, in coffee break area (material delivered by sponsor)
Rate: € 1500.-

C. BRONZE:
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Table Top + Poster Presentation during conference, in coffee break area (material delivered by sponsor)
Rate: € 900.-

D. USB STICKS for proceedings SOLD OUT
Logo on USB stick. The USB sticks being delivered by sponsoring company to all delegates (min. 1GB).
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 1100.-

E. BLOC NOTES SOLD OUT
The official event bloc notes will be delivered by EIPC to all delegates (front cover includes general event information and all sponsor logos)
Logo on bloc notes + notification "Bloc notes are sponsored by…."
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 1100.-

F. BADGE CORDS/LANYARDS SOLD OUT
This opportunity includes badge cords for use by visitors available at their disposal in the registration area. Badge cords delivered by sponsor.
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 1100.-

G. PENS:
This opportunity includes pens for use by visitors available at their disposal in the registration area. Pens delivered by sponsor.
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 1000.-

H. LOGO IN EIPC EVENT MAILINGS:
This opportunity includes a company logo with a link to the company website in every outgoing electronic mailing regarding to this event.
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 700.-

I. LOGO + REDUCED REGISTRATION FEE(S)
This opportunity includes a company logo with a link to the company website in every outgoing electronic mailing regarding to this event.
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate:
+ 1 delegate EIPC Member: € 1,000.-
+ 2 delegates EIPC Member: € 1,500.-
+ 3 delegates EIPC Member: € 1,990.-

+ 1 delegate NON Member: € 1,400.-
+ 2 delegates NON Member: € 1,990.-
+ 3 delegates NON Member: € 2,550.-

J. WELCOME DRINK @ NETWORKING DINNER
SOLD OUT
Visibility in all outgoing communication
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 1250.-
FIRST COME, FIRST SERVE

K. NETWORKING DINNER
Visibility in all outgoing communication: The "company name" networking dinner. The networking dinner is exclusively sponsored by "company name".
Cards with logo on the table during dinner
Logo on conference bloc notes
Logo in official sponsor list in digital proceedings
Logo in all outgoing communication
Rate: € 5,000.-/€ 10,000.- (depending on number of participants and menu)
FIRST COME, FIRST SERVE

Sponsor Submission Form
EIPC Winter Conference 2027

Company name……

Contact name……..……..

Address……..

Postal Code/City……..

Country……..

VAT number……..

Sponsor packages

O	**A) Gold package**	**€ 2000.-**
O	**B) Silver package**	**€ 1500.-**
O	**C) Bronze package**	**€ 900.-**
O	**D) USB Sticks**	**Sold out**
O	**E) Bloc notes**	**Sold out**
O	**F) Badge Cords/Lanyards**	**Sold out**
O	**G) Pens**	**€ 1000.-**
O	**H) Logo in Event mailings**	**€ 700.-**
O	**I) Logo + 1 EIPC Member registration € 1,000**	**O + 1 Non member registration € 1,400**
O	**I) Logo + 2 EIPC Member registrations € 1,500**	**O + 2 Non member registrations € 1,990**
O	**I) Logo + 3 EIPC Member registrations € 1,990**	**O + 3 Non member registrations € 2,550**
O	**J) Welcome drink @ networking dinner**	**Sold out**
O	**K) Networking Dinner**	**€ 5,000-€ 10,000**

Payment Information

O Please invoice my company – Purchase Order number (if required) ……

O Credit Card Payment (Please note: 5% commission payable by customer)

Signature

……



ISSUE 21 – NOVEMBER 2026

NEWS FROM AUSTRIA

Order book record high, net sales decrease AT&S showcased advanced integrated circuit substrates and complex printed circuit boards at electronica 2026 with around 50 experts, its largest delegation to the fair, and 87 meetings with customers and partners scheduled before it opened

November 9, 2026
AT&S

Strong customer interest and a record-sized delegation mark AT&S's tenth appearance at the world's leading electronics trade fair.

Leoben, November 9, 2026 - AT&S starts electronica 2026 with strong momentum: 87 meetings with customers and partners were already scheduled before the fair opened, while around 50 AT&S experts are heading to Munich, making this the company's largest delegation to electronica to date. The participant list includes teams from sales, application engineering, R&D, purchasing, and other functions.

At Booth 311 in Hall A2, AT&S will focus on advanced IC substrates and complex printed circuit boards, embedding technologies, and its European development and manufacturing capabilities. These technologies enable increasingly powerful and compact electronic systems for applications including AI, mobility, industrial technology, and medical technology.

Technology made tangible
Instead of a conventional product exhibition, the AT&S booth is designed around technical exchange. A large LED wall provides insights into technologies including IC substrates and embedding, complemented by physical samples and direct access to AT&S experts.
The strong interest comes as artificial intelligence and other high-performance applications increase demands on computing power, energy efficiency, miniaturization, and system integration. AI is also one of the central themes of electronica 2026.

"The Sales Team has scheduled almost 100 meetings with customers and partners already before electronica even started. This clearly shows the demand for direct contact between the customer community and our experts. electronica is the perfect platform to bring experts from across the value chain, both upstream and downstream, to discuss not only concrete challenges but also innovations, covering everything from high-performance computing and embedding technologies to manufacturing and product realization," says Andreas Wippel, VP BU Sales at AT&S.

AT&S welcomes customers, partners, and media representatives at Booth 311 in Hall A2 from November 10 to 13.



ISSUE 21 – NOVEMBER 2026

NEWS FROM GERMANY

Schweizer Electronic nine-month 2026 revenue rose 9.7% to EUR 139.9 million and order intake rose 41.2% to EUR 228.6 million, with a record order book of EUR 282.6 million and third-quarter EBIT of EUR 1.6 million

November 6, 2026
Schweizer Electronic

- Order book reaches a new high of EUR 282.6 million
- Revenue after nine months rises by 9.7% to EUR 139.9 million
- Profit turnaround in the third quarter - EBIT and profit return to positive territory

Schramberg, 6 November 2026 - The SCHWEIZER Group continued to see strong demand for its printed circuit board solutions in the first nine months of 2026. Order intake rose by 41.2% compared with the same period last year to EUR 228.6 million. The book-to-bill ratio stood at 1.6.
The order book also showed a clearly positive trend. As at 30 September 2026, it reached a new high of EUR 282.6 million, representing a 45.6% increase on the figure at the end of 2025. The high order book underscores the continued strong demand and provides an excellent foundation for further business development.

Revenue rose by 9.7% to EUR 139.9 million in the first nine months. Positive growth momentum came from sectors outside the automotive sector (notably industry, medical, aviation and defence). Revenue from these sectors rose by over 50% to EUR 31.3 million.
In line with the revenue trend, SCHWEIZER significantly improved its earnings position. Adjusted earnings before interest, taxes, depreciation and amortisation (EBITDA) reached EUR 3.5 million, compared with -0.5 million euros in the same period of the previous year. The adjustment relates to restructuring costs of EUR 0.4 million. The adjusted EBITDA margin stood at 2.5%.

The positive earnings trend continued in the third quarter. SCHWEIZER achieved an EBITDA of EUR 2.9 million and a positive operating profit (EBIT) of EUR 1.6 million. Net profit for the period also turned positive in the third quarter, amounting to +0.8 million euros. This marked

the turnaround in the third quarter and underlined the ongoing improvement in business performance.
Based on business performance in the first nine months, SCHWEIZER is refining its forecast for the full year 2026. The company now expects consolidated turnover of between 175 and 185 million euros and adjusted EBITDA of between 4 and 6 million euros. Positive effects are still expected from the product mix and product profitability. At the same time, the situation regarding the availability and price of supplier materials remains fragile.

Unimicron planned to close its Geldern, Germany printed circuit board plant, affecting around 240 employees with production set to end in the first half of 2027, and to inject up to EUR 35 million to complete orders, cover severance and liquidate the company.

October 27, 2026
Evertiq

Taiwanese PCB maker Unimicron plans to dissolve Unimicron Germany, its PCB plant in Geldern, to reduce operating costs. The group is injecting up to EUR 35 million into the company to complete existing orders, cover severance payments and pay for the liquidation.

The plan appears in two filings to the Taiwan Stock Exchange dated 27 October. Unimicron will inject up to EUR 35 million, paid in US dollars, into its subsidiary UniRuwel Holding, which owns all of Unimicron Germany. UniRuwel will then pass the money on to the German company. According to the filings, the dissolution is based on "group planning and operational considerations", and the transaction has been approved by Unimicron's board and audit committee.

The money will be used to fulfil existing orders, handle employee severance, repay bank loans and loans from the group, and cover the costs of liquidating the company. It will be booked as a capital contribution rather than new shares, so UniRuwel's holding in Unimicron Germany remains unchanged.

Just four years ago, Unimicron Germany was investing in the site. In 2022, the company spent around EUR 12 million on a new production building, equipment for desmearing and copper plating, and a new groundwater decontamination facility, as Evertiq reported at the time. The company said back then that it wanted to meet growing demand from the automotive, renewable energy, industrial and medical technology sectors.
The filings don't say how many employees are affected or when production will stop. According to the Rheinische Post, around 240 employees - the plant's entire workforce - are affected, and production is set to end in the first half of 2027.

In Data4PCB's ranking of Europe's 30 largest PCB manufacturers by 2024 revenue, presented by Dieter G. Weiss at Evertiq Expo Berlin last year, Unimicron ranked 12th, making it one of Germany's larger PCB manufacturers.

PCB Resilience Check: how well protected is your supply?

With AI data centres absorbing glass fabric, copper foil, laminate, and high-layer capacity, PCBs and their base materials are being allocated. Crowlight Partners has published a free, anonymous self-assessment that shows OEMs, Tier 1 suppliers, EMS providers, and PCB manufacturers where they stand.

In 13 questions and about five minutes, the PCB Resilience Check looks at qualified sources, visibility of the supply chain, stock coverage, contracts, forecasts, position with suppliers, and decision-making in a shortage. The result rates the situation in four dimensions and names the two levers to examine first. No registration is required, no answers are stored, and the check is available in English and German.

PCB manufacturers may also find it useful to share with their customers: it makes clear that in a shortage, capacity goes to customers who plan reliably and act as partners.

crowlightpartners.com/pcb-check/#en



ISSUE 21 - NOVEMBER 2026

NEWS FROM IRELAND

Ventec and MICAM to establish joint venture for European production of mission-critical copper-clad laminates in Ireland. New facility will strengthen sovereign European supply of materials for defence-grade electronics.

Ventec International Group (TWSE: 6672), a Taiwanese specialist manufacturer of copper-clad laminates (CCL) and prepregs (PP) serving a global customer base, and MICAM a long-established manufacturer of advanced composites to the industrial, security and defence industries are developing a joint venture to establish copper-clad laminate production at MICAM's manufacturing facility in Mallow, Ireland.

The project will add manufacturing capability within the European Union, strengthening supply security and supporting customers seeking regionally manufactured PCB base materials for defence applications.

The development marks the next step in Ventec's "China, Taiwan plus N" agile manufacturing and diversification strategy. Building on the Taiwanese company's established manufacturing operations in Taiwan and China, Thailand was the first addition to this programme. Ireland represents the latest step, extending Ventec's manufacturing capability into the EU.

Phase one will establish copper-clad laminate pressing capability at the Mallow facility, a practical step towards a more resilient European defence electronics supply chain. Equipment is currently being installed, with test pressing and pre-production planned for Q1 2027. Full production capability is scheduled to come on stream in Q2 2027.

Plans for phase two include the addition of state-of-the-art treating equipment to enable prepreg manufacture, further extending the facility's production capabilities.

Mark Goodwin, COO EMEA & USA, commented: *"Security of supply starts with the materials. If Europe wants a stronger defence electronics supply chain, it needs manufacturing capability at its foundations. Our joint venture with MICAM is a practical step towards that goal, bringing copper-clad laminate production into Ireland, with prepreg manufacturing planned as the next phase."*

Jason Chung, CEO of Ventec International Group, commented: *"As a Taiwanese company serving customers worldwide, we are continuing to diversify where we manufacture. Following our investment in Thailand, Ireland is the next step in our Taiwan, China plus N strategy, giving customers greater supply resilience and a dependable EU production option for materials critical to their defence programmes."*

Further details of the product range and phase-two development will be announced as the project progresses.

Further information about Ventec's solutions and the company's wide variety of products is available at www.venteclaminates.com



ISSUE 21 – NOVEMBER 2026

NEWS FROM KOREA

Lotte Energy Materials expects its high-end circuit copper foil business for artificial intelligence (AI) data centers to achieve a double-digit operating profit margin next year, driven by growing demand for high-value copper foil used in AI servers and high-speed networks. The company also plans to expand production capacity.

"We expect high-end circuit copper foil to achieve an operating profit margin of at least 10% next year as operations stabilize and production capacity expands," Lotte Energy Materials CEO Kim Yeon-seop said during the company's third-quarter 2026 earnings conference call on Nov. 5.

The company plans to make circuit copper foil a core product category, increasing its share of revenue from an estimated 14% this year to 40% by 2029.
To support the expansion, Lotte Energy Materials will increase annual circuit copper foil production capacity at its Iksan plant in North Jeolla Province from 6,700 tons to 16,000 tons by 2027 by adding post-processing facilities within the existing plant. The company is also considering further expansion in 2028 and the introduction of dedicated production equipment for hyper very low profile (HVLP) copper foil and ultra-thin copper foil (UTC).
Circuit copper foil is used in printed circuit boards (PCBs) and other applications. AI servers and high-speed networks use HVLP copper foil, which has lower surface roughness to minimize signal loss. HVLP is classified into five grades based on surface roughness and signal transmission loss, among other factors. Higher grades offer smoother surfaces and lower signal loss, making them better suited for high-speed data transmission. Lotte Energy Materials currently mass-produces Grade 3 and Grade 4 HVLP copper foil and is developing Grade 5.

The company forecasts that global HVLP demand will grow at a compound annual rate of 33% from 2026 through 2030, compared with current demand of less than 30,000 tons. It expects circuit copper foil sales volume to more than double next year, with high-end products accounting for over 50% of the total.
Production yield remains a challenge. The yield for Grade 1 HVLP, the lowest grade, is about

60%, below the 80% achieved for conventional circuit copper foil. Grades 3 and 4, which are already in mass production, are also still undergoing stabilization. The company plans to raise yields to levels comparable with global competitors by the end of this year.
Lotte Energy Materials is also developing its UTC business for optical transceivers. These devices convert electrical signals into optical signals and vice versa and are used in high-speed optical communication networks at AI data centers. The company supplies circuit copper foil to PCB customers within the global optical communications supply chain and is conducting UTC qualification tests with some customers.

Lotte Energy Materials reported third-quarter revenue of 289.7 billion won and an operating loss of 21.3 billion won. Revenue rose 101.6% from a year earlier, while the operating loss narrowed by about 13 billion won.

"We expect our Malaysian subsidiary, which produces battery copper foil, to turn profitable in the first or second quarter of next year," the company said. "On a consolidated basis, we expect to return to profitability in the second quarter of next year."



ISSUE 21 - NOVEMBER

NEWS FROM NORWAY

CONFIDEE has joined the French Norwegian Chamber of Commerce, which connects French and Norwegian companies and public organisations.

“We are pleased to welcome CONFIDEE to the French Norwegian Chamber of Commerce. Their experience in electronics, particularly within the defence sector, and their expertise in defence regulations and compliant supply chains bring valuable knowledge to our network. We look forward to their contribution to closer industrial cooperation between France and Norway,” says the French Norwegian Chamber of Commerce.

The Chamber of Commerce is part of the CCI France International Network.

“Protecting sensitive supply chains has always depended on trust between countries. Joining the French Norwegian Chamber of Commerce brings France and Norway, and their supply chains, a step closer,” says Didrik Bech, Board Member of CONFIDEE.

The cooperation between French and Norwegian industry is growing, and cross-border projects bring their own export-control and documentation requirements.

“As Europe builds more of its own defence capability, buyers need to know where their electronics come from and who has had access to the data along the way. That is some of the knowledge we want to share with French and Norwegian partners. We are looking forward to meeting, learning and sharing knowledge and experience,” says Bech.

CONFIDEE is certified to AS9120 for quality management and ISO 27001 for information security.



Picture of Didrik Bech, Board Member CONFIDEE.

News from WECC members

WECC World Electronic Circuits Council

Issue 21 – November 2026

NEWS FROM THE IPCA

India electronics manufacturers faced printed circuit board shortages and higher costs, with copper-clad laminate prices up between 200% and 350% across grades and 88% of board materials imported

November 10, 2026
Nikkei Asia

BENGALURU -- India's electronics manufacturers are facing high costs and supply constraints for printed circuit boards as an increasing amount of capacity is captured by the booming demand for artificial intelligence-related hardware.

A PCB, an essential part of products ranging from smartphones to cars, mechanically supports and electrically connects electronic components. "I call it the invisible backbone of electronics," said Rajneesh Garg, president of the Indian Printed Circuit Board Association.

Increasingly, the PCB industry has transitioned from standard hardware backbones into more advanced and specialized pieces of engineering for more demanding AI applications. PCB makers globally are diverting more production to this high-margin market, leaving traditional electronics companies in short supply.

"Every raw material has been diverted to that sector," Garg said. India's vulnerability is particularly acute.

The country has grown its electronics assembly industry from scratch via national subsidy programs. Electronics exports grew over elevenfold from the fiscal year ending March 2015 to fiscal 2026, making it a key success story in Prime Minister Narendra Modi's "Make in India" push. India's PCB market is growing at a compound annual rate of 15%, according to the IPCA, making it one of the country's fastest expanding industries.

At the same time, India manufactures few of the components that make up electronics. Its import bill for such items, including PCBs, has grown alongside its finished exports, paving the way for a multibillion-dollar subsidy program in 2025 to deepen local value addition. Of the materials used to make a PCB, 88% are imported, including copper-clad laminates, electronic-grade glass cloth and low-bromine epoxy resin.

"The shortages started somewhere in the early part of this year," said Jasbir Singh Gujral, managing director of electronic manufacturing services company Syrma SGS.
Under the electronic components subsidy program announced last year, Syrma is on track to set up India's largest PCB plant. Commercial production is expected to commence from April next year, initially in small batches for approval, Gujral said.
"The real challenge will be when the whole plant goes into serious production... I hope by that point of time it (the supply chain situation) will have eased out," Gujral said.

Industry experts, including Garg, said that the shortages could last up to a year.
"The cost of every key raw material rose in the last nine to 10 months with no exceptions," said Rajoo Goel, secretary general at the Electronic Industries Association of India.

Goel added that prices of electronic-grade glass cloth have doubled in the past eight months, while those of low-bromine epoxy resin have risen up to 70%. Copper-clad laminates have seen the steepest rise at between 200% and 350% across grades.
The steep rises have led some Indian PCB makers to negotiate price increases with their clients, which include carmakers and companies like Syrma. In turn, those prices are being passed on to consumers.

In July, the IPCA approached the government to request a lowering of import duties on some PCB components to ease costs. It also requested top carmakers -- some of the biggest PCB buyers -- to ask copper-clad laminate suppliers to reserve some for Indian PCB makers. However, on both fronts, there has been little progress, Garg said."The prices are so high that the factories, the companies buying the PCBs, their prices will go up, which can impact demand," .

India's festive season, which typically runs from October to December, usually sees the highest volume of sales across electronics and lifestyle goods, with companies offering discounts. But it is different this year, Garg noted.

"In the festive season, when we expect discount structures and hyper sales and special days for bulk sales, Apple has not lowered their prices of mobile phones," he said. "Air conditioning companies, refrigerator makers are also not giving products on discount. Rather, they have announced price increases. Every carmaker has announced price increases."



International Diary

2026

FED Austrian Electronics Day
26 November
Dornbirn, Austria

HKPCA
2-4 December
Shenzhen, Hong Kong

2027

EIPC Winter Conference
2 & 3 February
Visit TKMS Atlas Elektronik GmbH
Bremen, Germany

IPC APEX EXPO
March
Anaheim Convention Center, California, USA

CPCA
March
Shanghai, China

JPCA
June
Tokyo, Japan

EIPC Summer Conference
8 & 9 June

Electronics Manufacturing & Packaging Symposium (EMPS)
28 June-1 July
ESA/ESTEC Noordwijk, NL

IPCA
July
New Delhi, India

ECWC17 Electronics Circuit World Convention
18-20 August
Bangkok, Thailand

KPCA
September
Incheon, Korea

EIPC @ FED Conference
15 & 16 September
Mannheim, Germany

TPCA
October
Taipei, Taiwan

EIPC @ Productronica
16-19 November
Munchen, Germany

HKPCA
December
Shenzhen, Hong Kong

2028

EIPC Winter Conference
8 & 9 February
Visit Schmoll Maschinen
Rödermark, Germany